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STPS120L15TV

LOW DROP OR-ing POWER SCHOTTKY DIODE

MAIN PRODUCT CHARACTERISTICS

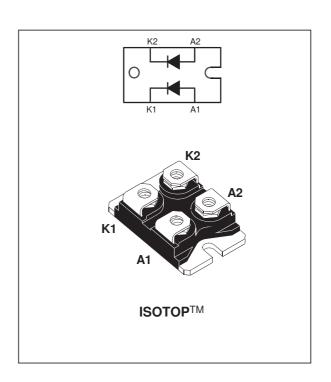
I _{F(AV)}	2 x 60 A
V _{RRM}	15 V
Tj (max)	125 °C
V _F (max)	0.31 V

FEATURES AND BENEFITS

- VERY LOW DROP FORWARD VOLTAGE FOR LESS POWER DISSIPATION AND REDUCED HEATSINK
- INSULATED PACKAGE: Insulated voltage = 2500 V_(RMS) Capacitance = 45 pF
- AVALANCHE CAPABILITY SPECIFIED

DESCRIPTION

Dual Schottky rectifier suited for Switched Mode Power Supplies and DC to DC power converters. Packaged in ISOTOPTM, this device is especially intended for use as an OR-ing diode in fault tolerant power supply equipments.



ABSOLUTE RATINGS (limiting values, per diode)

Symbol	Parameter	Value	Unit	
V _{RRM}	Repetitive peak reverse voltage	15	V	
I _{F(RMS)}	RMS forward current	160	Α	
I _{F(AV)}	Average forward current	Tc = 115°C δ = 1	60	Α
I _{FSM}	Surge non repetitive forward current	tp = 10 ms Sinusoidal	1200	Α
I _{RRM}	Repetitive peak reverse current	tp = 2μs F = 1kHz	2	Α
P _{ARM}	Repetitive peak avalanche power	tp = 1μs Tj = 25°C	72030	W
T _{stg}	Storage temperature range		- 65 to + 150	°C
Tj	Maximum operating junction temperature	125	°C	
dV/dt	Critical rate of rise of reverse voltage	10000	V/µs	

* :
$$\frac{dPtot}{dTj} < \frac{1}{Rth(j-a)}$$
 thermal runaway condition for a diode on its own heatsink

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July 2003 - Ed :54A

THERMAL RESISTANCES

Symbol	Parameter	Value	Unit	
R _{th (j-c)}	Junction to case	Per diode	0.45	°C/W
		Total	0.28	
R _{th (c)}		Coupling	0.1]

STATIC ELECTRICAL CHARACTERISTICS (per diode)

Symbol	Parameter	Tests conditions		Min.	Тур.	Max.	Unit
I _R *	Reverse leakage current	Tj = 100°C	$V_R = 5V$		450		mA
		Tj = 25°C	V _R = 12V			22	mA
		Tj = 100°C			0.7	2.2	Α
V _F *	Forward voltage drop	Tj = 25°C	I _F = 60 A			0.43	V
		Tj = 125°C	I _F = 60 A		0.27	0.31	

Pulse test: * tp = 380 μ s, δ < 2%

To evaluate the conduction losses use the following equation : $P=0.18~x~I_{F(AV)}+2.2~10^{-3}~x~I_{F}^2_{(RMS)}$

Fig. 1: Average forward power dissipation versus average forward current (per diode).

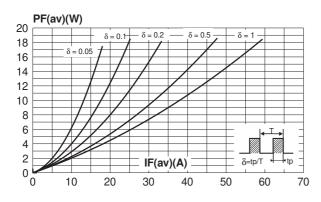


Fig. 3: Normalized avalanche power derating versus pulse duration.

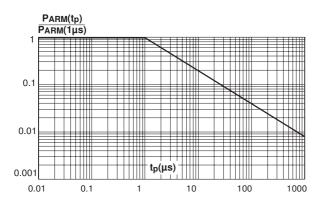


Fig. 2: Average forward current versus ambient temperature ($\delta = 1$) (per diode).

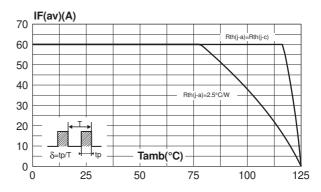
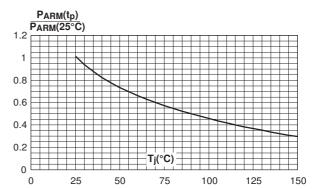


Fig. 4: Normalized avalanche power derating versus junction temperature.



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Fig. 5: Non repetitive surge peak forward current versus overload duration (maximum values per diode).

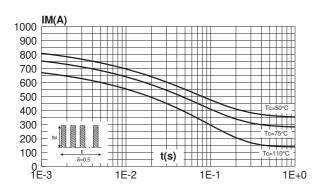


Fig. 6: Relative variation of thermal impedance junction to case versus pulse duration.

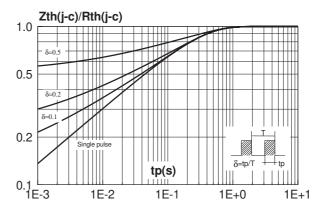


Fig. 7: Reverse leakage current versus reverse voltage applied (typical values per diode).

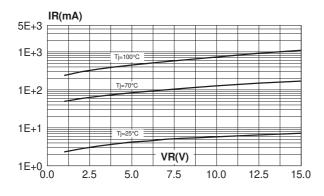


Fig. 8: Junction capacitance versus reverse voltage applied (typical values per diode).

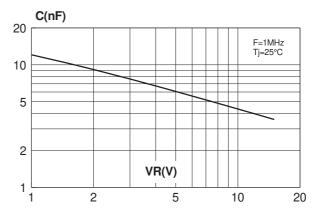
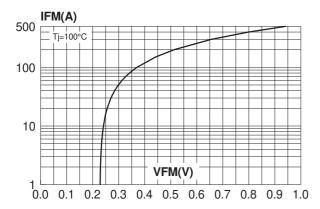


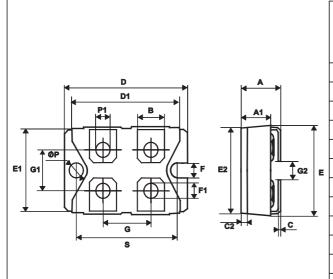
Fig. 9: Forward voltage drop versus forward current (maximum values per diode).



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PACKAGE MECHANICAL DATA

ISOTOP



DIMENSIONS				
Millin	neters	Inches		
Min.	Min. Max.		Max.	
11.80	12.20	0.465	0.480	
8.90	9.10	0.350	0.358	
7.8	8.20	0.307	0.323	
0.75	0.85	0.030	0.033	
1.95	2.05	0.077	0.081	
37.80	38.20	1.488	1.504	
31.50	31.70	1.240	1.248	
25.15	25.50	0.990	1.004	
23.85	24.15	0.939	0.951	
24.80	24.80 typ.		6 typ.	
14.90	15.10	0.587	0.594	
12.60	12.80	0.496	0.504	
3.50	4.30	0.138	0.169	
4.10	4.30	0.161	0.169	
4.60	5.00	0.181	0.197	
4.00	4.30	0.157	0.69	
4.00	4.40	0.157	0.173	
30.10	30.30	1.185	1.193	
	Min. 11.80 8.90 7.8 0.75 1.95 37.80 31.50 25.15 23.85 24.80 14.90 12.60 3.50 4.10 4.60 4.00	Millimeters Min. Max. 11.80 12.20 8.90 9.10 7.8 8.20 0.75 0.85 1.95 2.05 37.80 38.20 31.50 31.70 25.15 25.50 23.85 24.15 24.80 typ. 14.90 12.60 12.80 3.50 4.30 4.10 4.30 4.00 4.30 4.00 4.40	Millimeters Inc Min. Max. Min. 11.80 12.20 0.465 8.90 9.10 0.350 7.8 8.20 0.307 0.75 0.85 0.030 1.95 2.05 0.077 37.80 38.20 1.488 31.50 31.70 1.240 25.15 25.50 0.990 23.85 24.15 0.939 24.80 typ. 0.970 14.90 15.10 0.587 12.60 12.80 0.496 3.50 4.30 0.138 4.10 4.30 0.161 4.60 5.00 0.181 4.00 4.40 0.157 4.00 4.40 0.157	

Ordering type	Marking	Package	Weight	Base qty	Delivery mode
STPS120L15TV	STPS120L15TV	ISOTOP	28g (without screws)	10	Tube

- Cooling method: by conduction (C)
- Recommended torque value: 1.3 N.m.
- Maximum torque value: 1.5 N.m.
- Epoxy meets UL94,V0

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